TOSHIBA Intelligent Power Device High Voltage Monolithic Silicon Power IC

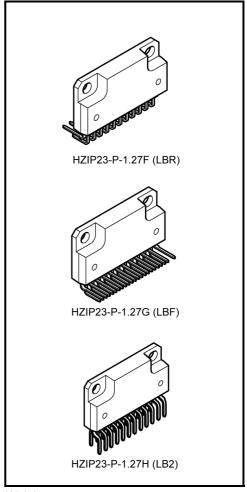
TPD4103K

The TPD4103K is a DC brushless motor driver using high voltage PWM control. It is fabricated by high voltage SOI process. It contains level shift high-side driver, low side driver, IGBT outputs, FRDs and protective functions for over current and under voltage protection circuits, and thermal shutdown circuit. It is easy to control a DC brushless motor by just putting logic inputs from a MPU or motor controller to the TPD4103K.

Features

- Bootstrap circuit gives simple high side power supply.
- Bootstrap diodes are built in.
- A dead time can be set as a minimum of 1.4 μs , and it is the best for a Sine-wave from drive.
- 3-phase bridge output using IGBTs.
- FRDs are built in.
- Included over current and under voltage protection, and thermal shutdown.
- The regulator of 7V (typ.) is built in.
- Package: 23-pin HZIP.

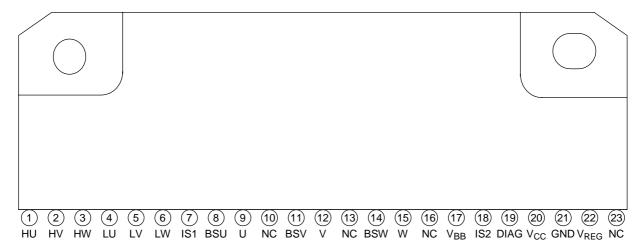
This product has a MOS structure and is sensitive to electrostatic discharge. When handling this product, ensure that the environment is protected against electrostatic discharge.



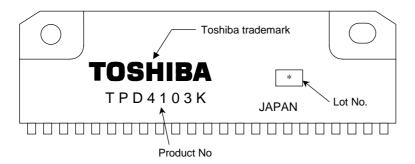
Weight

HZIP23-P-1.27F: 6.1 g (typ.) HZIP23-P-1.27G: 6.1 g (typ.) HZIP23-P-1.27H: 6.1 g (typ.)

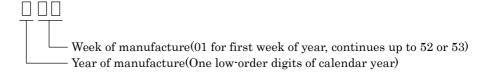
Pin Assignment



Marking

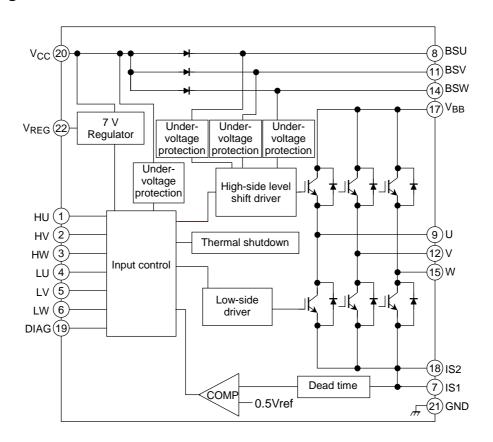


* Weekly code:(Three digits)



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Block Diagram



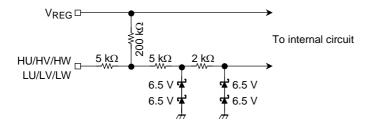
Pin Description

Pin No.	Symbol	Pin Description					
1	HU	The control terminal of IGBT by the side of U top arm. It turns on less than by 1.5 V. It turns off more than by 3.5 V.					
2	HV	The control terminal of IGBT by the side of V top arm. It turns on less than by 1.5 V. It turns off more than by 3.5 V.					
3	HW	The control terminal of IGBT by the side of W top arm. It turns on less than by 1.5 V. It turns off more than by 3.5 V.					
4	LU	The control terminal of IGBT by the side of U bottom arm. It turns on less than by 1.5 V. It turns off more than by 3.5 V.					
5	LV	The control terminal of IGBT by the side of V bottom arm. It turns on less than by 1.5 V. It turns off more than by 3.5 V.					
6	LW	The control terminal of IGBT by the side of W bottom arm. It turns on less than by 1.5 V. It turns off more than by 3.5 V.					
7	IS1	IGBT emitter and FRD anode pin. (Connect a current detecting resistor to this pin.)					
8	BSU	U-phase bootstrap capacitor connecting pin.					
9	U	U-phase output pin.					
10	NC	Unused pin, which is not connected to the chip internally.					
11	BSV	V-phase bootstrap capacitor connecting pin.					
12	V	V-phase output pin.					
13	NC	Unused pin, which is not connected to the chip internally.					
14	BSW	W-phase bootstrap capacitor connecting pin.					
15	W	W-phase output pin.					
16	NC	Unused pin, which is not connected to the chip internally.					
17	V _{BB}	High-voltage power supply input pin.					
18	IS2	IGBT emitter and FRD anode pin. (Connect a current detecting resistor to this pin.)					
19	DIAG	With the diagnostic output terminal of open drain, a pull-up is carried out by resistance. It turns it on at the time of unusual.					
20	Vcc	Control power supply pin. (15V typ.)					
21	GND	Ground pin.					
22	V _{REG}	7 V regulator output pin.					
23	NC	Unused pin, which is not connected to the chip internally.					

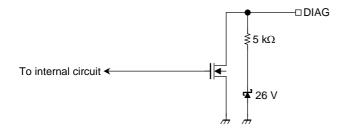
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Equivalent Circuit of Input Pins

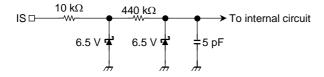
Internal circuit diagram of HU, HV, HW, LU, LV, LW input pins



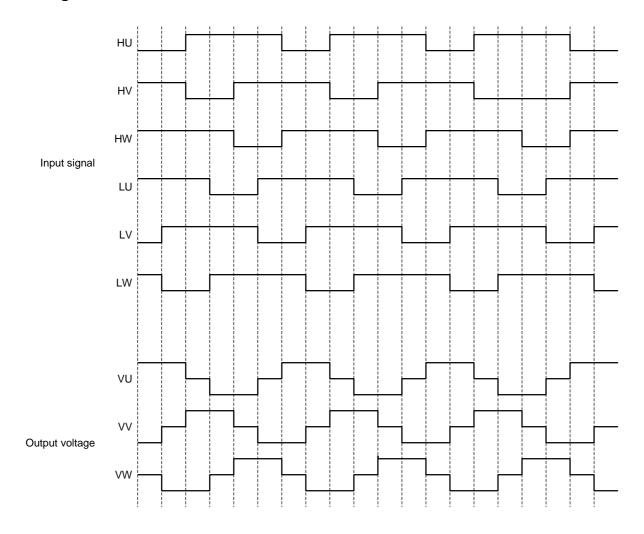
Internal circuit diagram of DIAG pin



Internal circuit diagram of IS pin



Timing Chart



Truth Table

Mode	Input						Top arm		Bottom arm				
	HU	HV	HW	LU	LV	LW	U phase	V phase	W phase	U phase	V phase	W phase	DIAG
Normal	L	Н	Н	Н	L	Н	ON	OFF	OFF	OFF	ON	OFF	OFF
	L	Н	Н	Н	Н	L	ON	OFF	OFF	OFF	OFF	ON	OFF
	Н	L	Н	Н	Н	L	OFF	ON	OFF	OFF	OFF	ON	OFF
	Н	L	Н	L	Н	Н	OFF	ON	OFF	ON	OFF	OFF	OFF
	Н	Н	L	L	Н	Н	OFF	OFF	ON	ON	OFF	OFF	OFF
	Н	Н	L	Н	L	Н	OFF	OFF	ON	OFF	ON	OFF	OFF
	L	Н	Н	Н	L	Н	OFF	OFF	OFF	OFF	OFF	OFF	ON
Over current	Ш	Н	Н	H	Н	L	OFF	OFF	OFF	OFF	OFF	OFF	ON
	H	L	Н	H	Н	L	OFF	OFF	OFF	OFF	OFF	OFF	ON
	Н	L	Н	L	Н	Н	OFF	OFF	OFF	OFF	OFF	OFF	ON
	Н	Н	L	L	Н	Н	OFF	OFF	OFF	OFF	OFF	OFF	ON
	Н	Н	L	Н	L	Н	OFF	OFF	OFF	OFF	OFF	OFF	ON
	L	Н	Н	Н	L	Н	OFF	OFF	OFF	OFF	OFF	OFF	ON
	L	Н	Н	Н	Н	L	OFF	OFF	OFF	OFF	OFF	OFF	ON
Thermal	Η	L	Н	Η	Н	L	OFF	OFF	OFF	OFF	OFF	OFF	ON
shutdown	Η	L	Н	Ш	Н	Н	OFF	OFF	OFF	OFF	OFF	OFF	ON
	Н	Н	L	L	Н	Н	OFF	OFF	OFF	OFF	OFF	OFF	ON
	Η	Н	L	H	L	Н	OFF	OFF	OFF	OFF	OFF	OFF	ON
Under voltage	Ш	Н	Н	Η	L	Н	OFF	OFF	OFF	OFF	OFF	OFF	ON
	Ш	Н	Н	H	Н	L	OFF	OFF	OFF	OFF	OFF	OFF	ON
	Н	L	Н	Н	Н	L	OFF	OFF	OFF	OFF	OFF	OFF	ON
	Н	L	Н	L	Н	Н	OFF	OFF	OFF	OFF	OFF	OFF	ON
	Н	Н	L	L	Н	Н	OFF	OFF	OFF	OFF	OFF	OFF	ON
	Н	Н	L	Н	L	Н	OFF	OFF	OFF	OFF	OFF	OFF	ON

Notes: Release of Thermal shutdown protection and under voltage protection depends release of a self-reset and over current protection on an all "H" input.

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Absolute Maximum Ratings (Ta = 25°C)

Characteristics	Symbol	Rating	Unit
Power supply voltage	V_{BB}	500	V
Fower supply voltage	V _{CC}	18	V
Output current (DC)	l _{out}	1	Α
Output current (pulse)	l _{out}	2	Α
Input voltage	V _{IN}	-0.5~7	V
V _{REG} current	I _{REG}	50	mA
Power dissipation (Ta = 25°C)	PC	4	W
Power dissipation (Tc = 25°C)	PC	20	W
Operating temperature	T _{jopr}	-20~135	°C
Junction temperature	Tj	150	°C
Storage temperature	T _{stg}	-55~150	°C
Lead-heat sink isolation voltage	Vhs	1000 (1 min)	Vrms

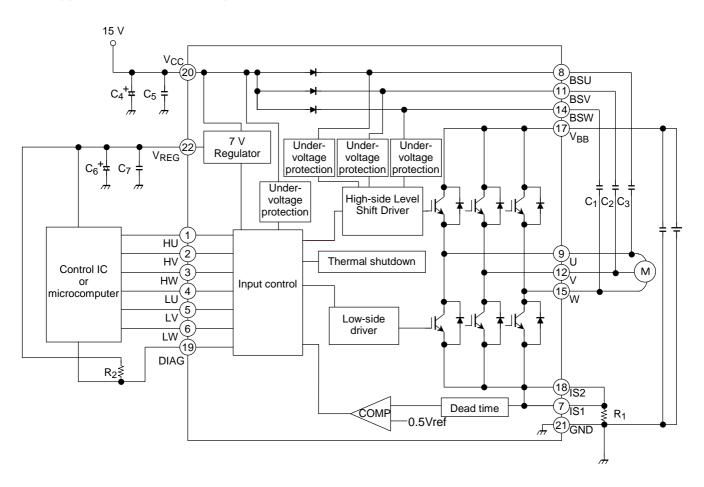
TPD4103K



Electrical Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit	
Operating power supply voltage	V_{BB}	_	50	280	400	V	
Operating power supply voltage	V _{CC}	_	13.5	15	16.5	V	
	I _{BB}	V _{BB} = 400 V	_	0.1	0.5	mA	
Current dissination	Icc	V _{CC} = 15 V	_	1.1	5	ША	
Current dissipation	I _{BS (ON)}	V _{BS} = 15 V, high side ON	_	260	410	^	
	I _{BS (OFF)}	V _{BS} = 15 V, high side OFF	_	230	370	μΑ	
Input voltage	V_{IH}	V _{IN} = "H"	3.5	_	_	V	
Input voltage	V _{IL}	V _{IN} = "L"	_	_	1.5		
Input current	I _{IH}	V _{IN} = 5 V	_	_	100	μА	
input current	I _{IL}	V _{IN} = 0 V	_	_	150	μА	
Output acturation valtage	V _{CEsat} H	V _{CC} = 15 V, IC = 0.5 A	_	2.4	3.0	V	
Output saturation voltage	V _{CEsat} L	V _{CC} = 15 V, IC = 0.5 A	_	2.4	3.0	V	
EDD forward valtage	V _F H	IF = 0.5 A, high side	_	1.3	2.0	V	
FRD forward voltage	V _F L	IF = 0.5 A, low side	_	1.3	2.0		
BSD forward voltage	V _F (BSD)	IF = 500 μA	_	0.9	_	V	
Regulator voltage	V_{REG}	V _{CC} = 15 V, I _O = 30 mA	6.5	7	7.5	V	
Current limiting voltage	V _R	_	0.45	0.5	0.55	V	
Current limiting dead time	Dt	_	2.3	3.3	4.4	μS	
Thermal shutdown temperature	TSD		150	165	200	°C	
Thermal shutdown hysteresis	ΔTSD		_	20	_	°C	
V _{CC} under voltage protection	V _{CC} UVD	_	10	11	12	V	
V _{CC} under voltage protection recovery	V _{CC} UVR	_	10.5	11.5	12.5	V	
V _{BS} under voltage protection	V _{BS} UVD	_	8	9	9.5	V	
V _{BS} under voltage protection recovery	V _{BS} UVR	_	8.5	9.5	10.5	V	
DIAG saturation voltage	V _{DIAGsat}	I _{DIAG} = 5 mA	_	_	0.5	V	
Output on delay time	t _{on}	V _{BB} = 280 V, IC = 0.5 A	_	1.5	3.0	μS	
Output off delay time	t _{off}	V _{BB} = 280 V, IC = 0.5 A	_	1.2	3.0	μS	
Dead time	tdead	V _{BB} = 280 V, IC = 0.5 A	1.4	_	_	μS	
FRD reverse recovery time	t _{rr}	V _{BB} = 280 V, IC = 0.5 A	_	200	_	ns	

Application Circuit Example



External Parts

Standard external parts are shown in the following table.

Part	Recommended Value	Purpose	Remarks	
C ₁ , C ₂ , C ₃	25 V/2.2 μF	Bootstrap capacitor	(Note 1)	
R ₁	$0.62~\Omega\pm1\%~(1~W)$	Current detection	(Note 2)	
C ₄	25 V/10 μF	V _{CC} power supply stability	(Note 3)	
C ₅	25 V/0.1 μF	V _{CC} for surge absorber	(Note 3)	
C ₆	16 V/1 μF	V _{REG} power supply stability	(Note 3)	
C ₇	16 V/1000 pF	V _{REG} for surge absorber	(Note 3)	
R ₃	5.1 kΩ	DIAG pin pull-up resistor	(Note 4)	

- Note 1: The required bootstrap capacitance value varies according to the motor drive conditions. The capacitor is biased by V_{CC} and must be sufficiently derated for it.
- Note 2: The following formula shows the detection current: $I_O = V_R \div RIS$ (For $V_R = 0.5 \text{ V}$) Do not exceed a detection current of 1 A when using this product.
- Note 3: When using this product, some adjustment is required in accordance with the use environment. When mounting, place as close to the base of this product leads as possible to improve the ripple and noise elimination.
- Note 4: The DIAG pin is open drain. Note that when the DIAG pin is connected to a power supply with a voltage higher than or equal to the V_{CC}, a protection circuit is triggered so that the current flows continuously. If not using the DIAG pin, connect to the GND.

Handling precautions

- (1) Please control the input signal in the state to which the V_{CC} voltage is steady. Both of the order of the VBB power supply and the V_{CC} power supply are not cared about either. Note that if the power supply is switched off as described above, this product may be destroyed if the current regeneration route to the V_{BB} power supply is blocked when the V_{BB} line is disconnected by a relay or similar while the motor is still running.
- (2) The IS pin connecting the current detection resistor is connected to a comparator in this product and also functions as a sensor pin for detecting over current. As a result, over voltage caused by a surge voltage, for example, may destroy the circuit. Accordingly, be careful of handling this product or of surge voltage in its application environment.

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Description of Protection Function

(1) Over current protection

This product incorporates the over current protection circuit to protect itself against over current at startup or when a motor is locked. This protection function detects voltage generated in the current detection resistor connected to the IS pin. When this voltage exceeds $VR=0.5\ V$ (typ.), the IGBT output, which is on, temporarily shuts down after a dead time, preventing any additional current from flowing to this product. The next all "H" signal releases the shutdown state.

(2) Under voltage protection

This product incorporates the under voltage protection circuit to prevent the IGBT from operating in unsaturated mode when the VCC voltage or the VBS voltage drops.

When the VCC power supply falls to this product internal setting (VCCUVD = 11 V typ.), all IGBT outputs shut down regardless of the input. This protection function has hysteresis. When the VCCUVR (= 11.5 V typ.) reaches 0.5 V higher than the shutdown voltage, this product is automatically restored and the IGBT is turned on again by the input.

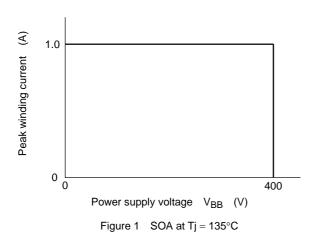
When the VBS supply voltage drops (VBSUVD = 9 V typ.), the high-side IGBT output shuts down. When the VBSUVR (= 9.5 V typ.) reaches 0.5 V higher than the shutdown voltage, the IGBT is turned on again by the input signal.

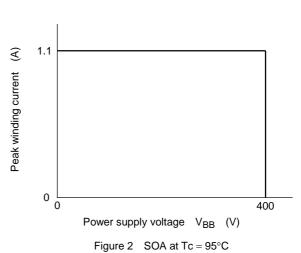
(3) Thermal shutdown

This product incorporates the thermal shutdown circuit to protect itself against the abnormal state when its temperature rises excessively.

When the temperature of this chip rises due to external causes or internal heat generation and the internal setting TSD reaches 165°C, all IGBT outputs shut down regardless of the input. This protection function has hysteresis (Δ TSD = 20°C typ.). When the chip temperature falls to TSD – Δ TSD, the chip is automatically restored and the IGBT is turned on again by the input. Because the chip contains just one temperature detection location, when the chip heats up due to the IGBT, for example, the differences in distance from the detection location in the IGBT (the source of the heat) cause differences in the time taken for shutdown to occur. Therefore, the temperature of the chip may rise higher than the thermal shutdown temperature when the circuit started to operate.

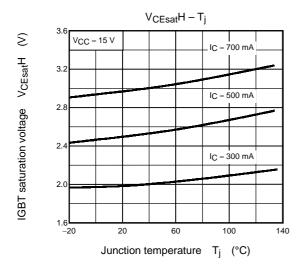
Safe Operating Area

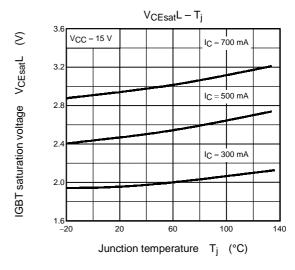


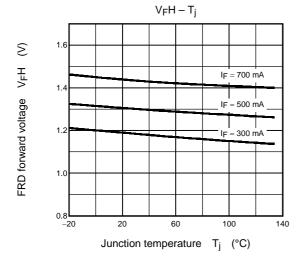


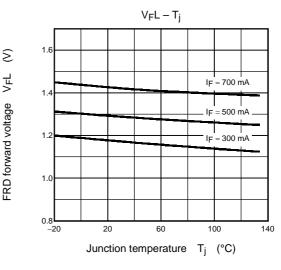
Note 1: The above safe operating areas are $Tj = 135^{\circ}C$ (Figure 1) and $Tc = 95^{\circ}C$ (Figure 2). If the temperature exceeds these, the safe operation areas reduce.

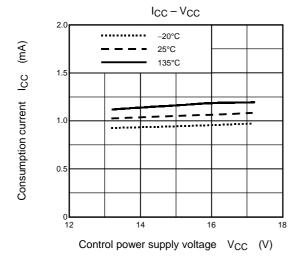
Note 2: The above safe operating areas include the over current protection operation area.

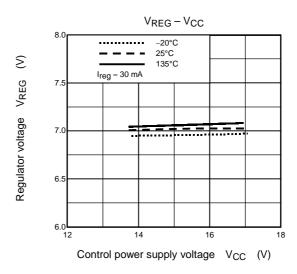


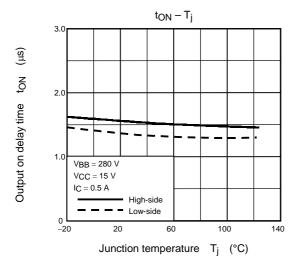


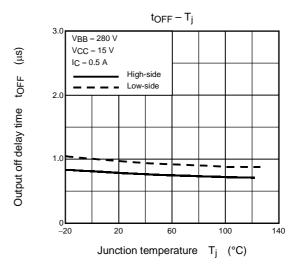


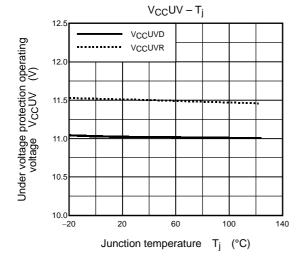


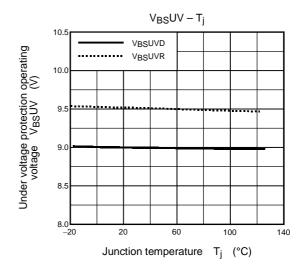


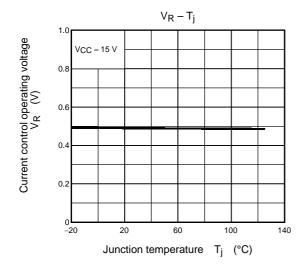


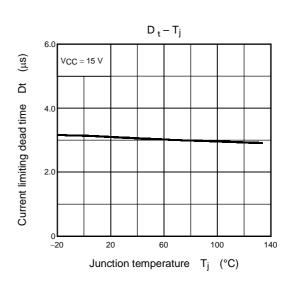


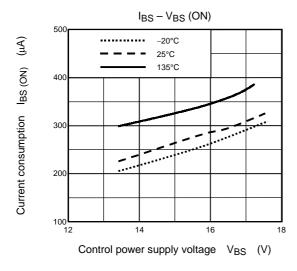


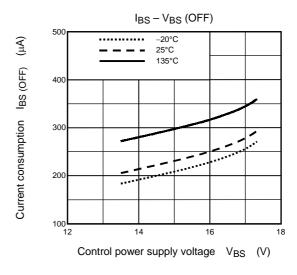


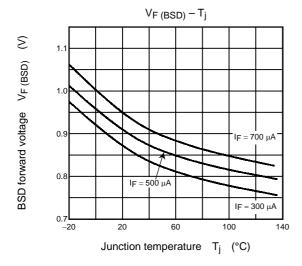


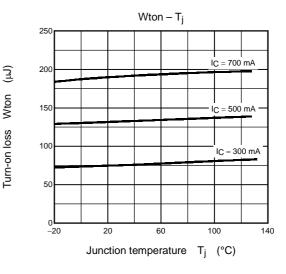


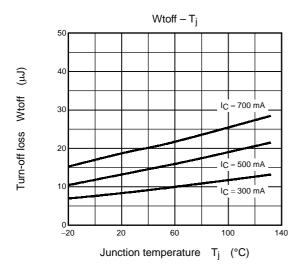






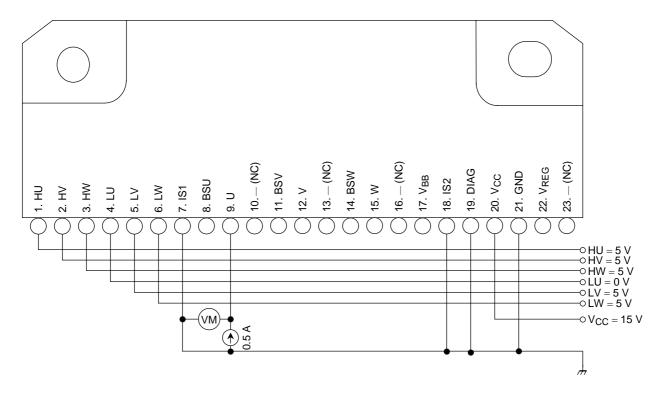




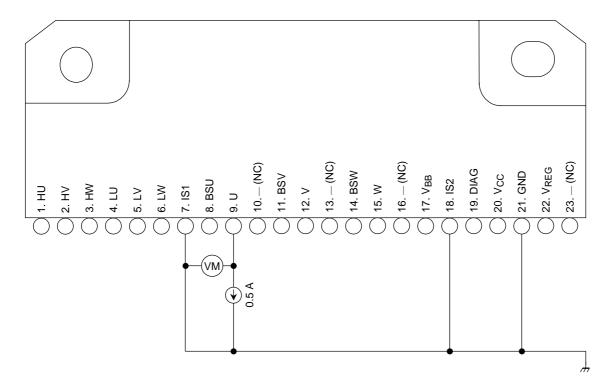


Test Circuits

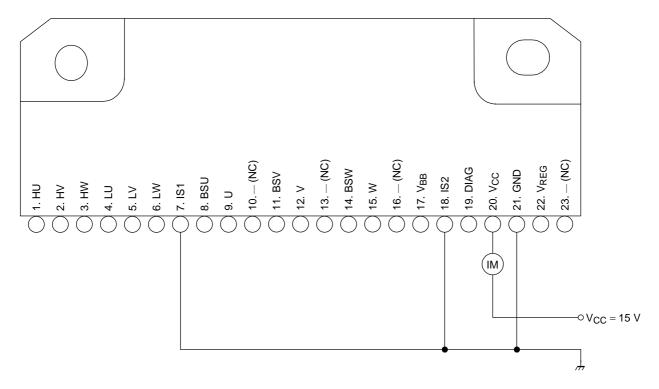
IGBT Saturation Voltage (U-phase low side)



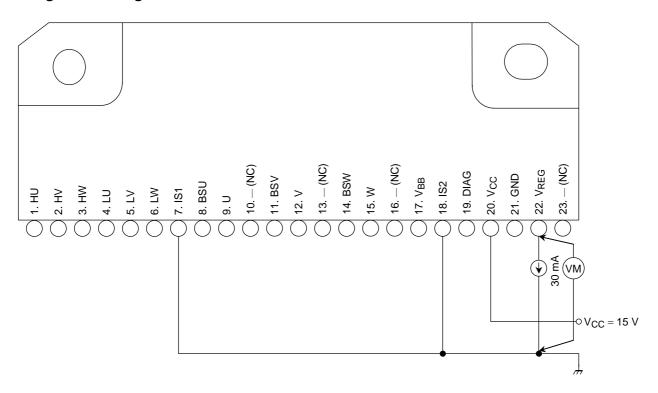
FRD Forward Voltage (U-phase low side)



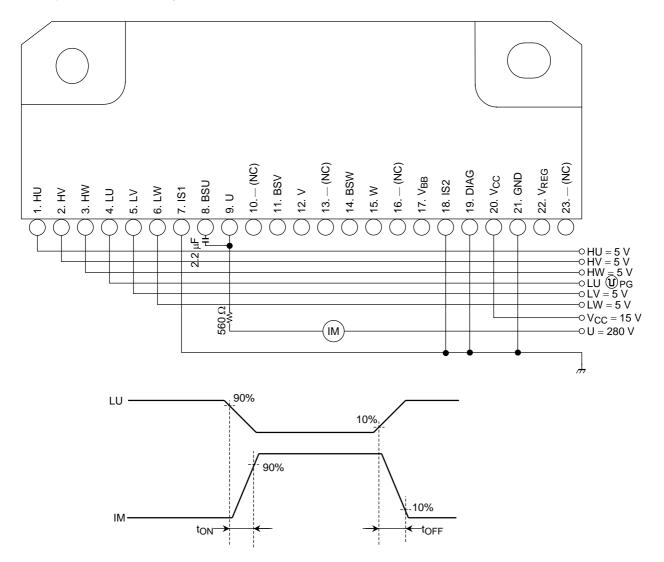
V_{CC} Current Dissipation



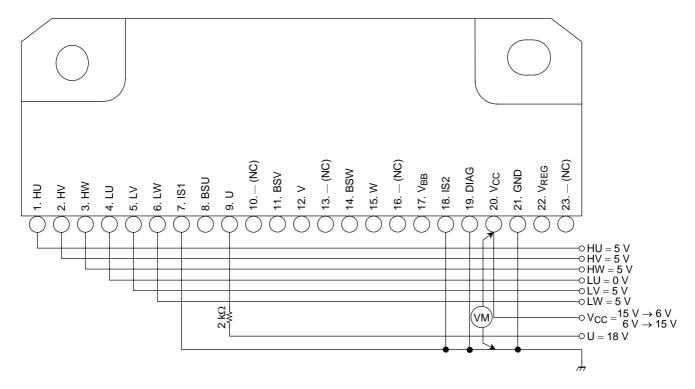
Regulator Voltage



Output ON/OFF Delay Time (U-phase low side)



V_{CC} Under voltage Protection Operation/Recovery Voltage (U-phase low side)

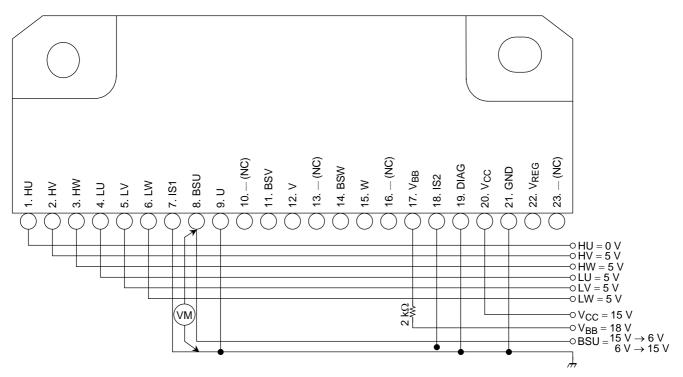


Note: Sweeps the V_{CC} pin voltage from 15 V to decrease and monitors the U pin voltage.

The V_{CC} pin voltage when output is off defines the under voltage protection operating voltage.

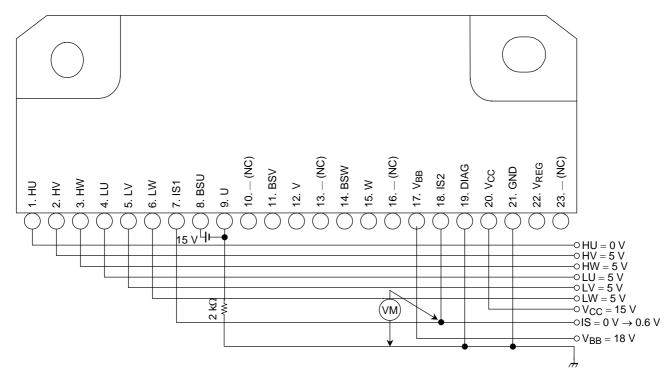
Also sweeps from 6 V to increase. The V_{CC} pin voltage when output is on defines the under voltage protection recovery voltage.

V_{BS} Under voltage Protection Operation/Recovery Voltage (U-phase high side)



Note: Sweeps the BSU pin voltage from 15 V to decrease and monitors the V_{BB} pin voltage. The BSU pin voltage when output is off defines the under voltage protection operating voltage. Also sweeps the BSU pin voltage from 6 V to increase and change the HU pin voltage at 0 V \rightarrow 5 V \rightarrow 0 V. The BSU pin voltage when output is on defines the under voltage protection recovery voltage.

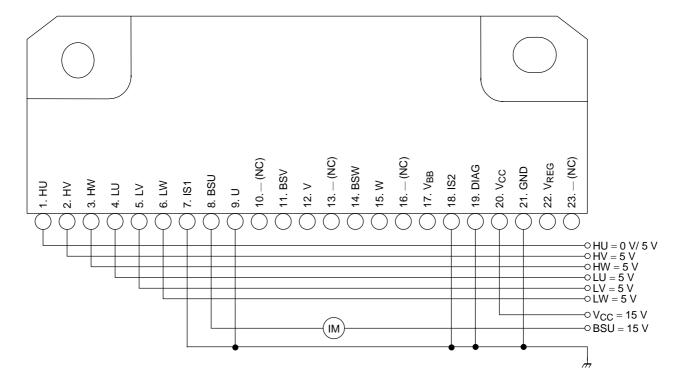
Current Control Operating Voltage (U-phase high side)



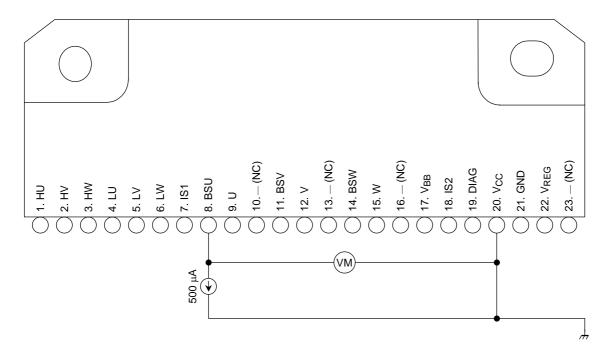
Note: Sweeps the IS pin voltage to increase and monitors the U pin voltage.

The IS pin voltage when output is off defines the current control operating voltage.

V_{BS} Current Consumption (U-phase high side)

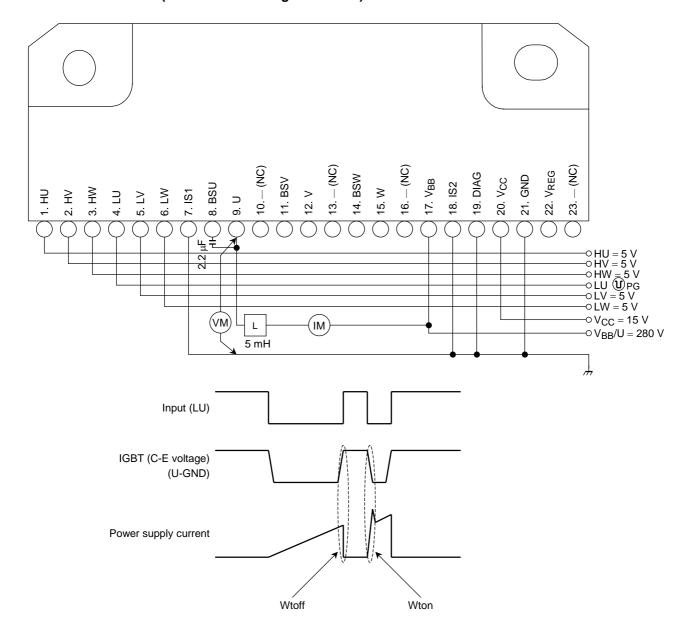


BSD Forward Voltage (U-phase)



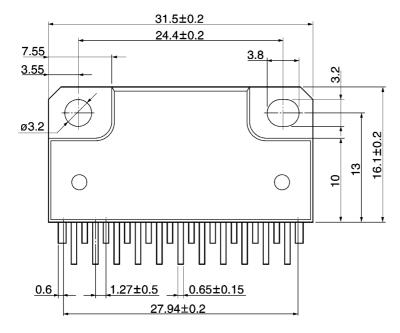
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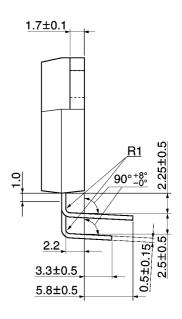
Turn-On/Off Loss (low-side IGBT + high-side FRD)

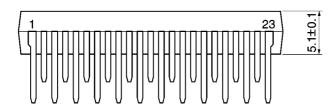


Package Dimensions

HZIP23-P-1.27F Unit: mm





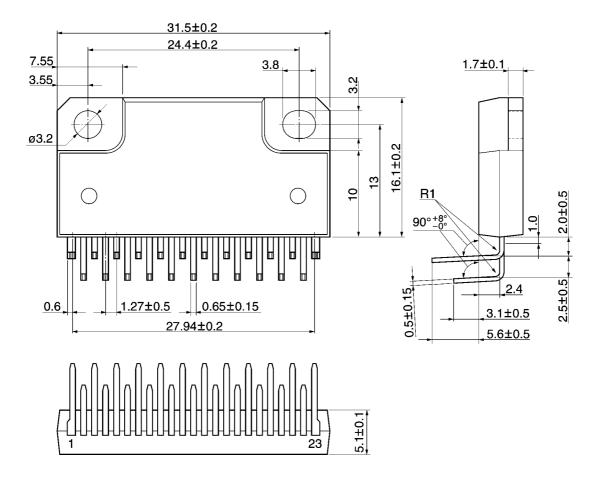


Weight: 6.1 g (typ.)



Package Dimensions

HZIP23-P-1.27G Unit: mm

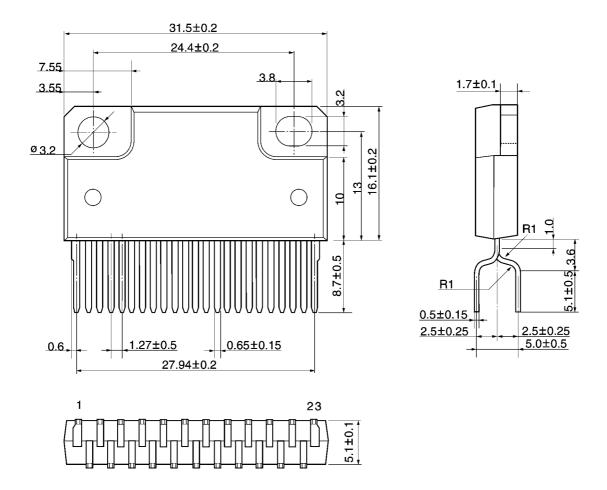


Weight: 6.1 g (typ.)

TPD4103K

Package Dimensions

HZIP23-P-1.27H Unit: mm



Weight: 6.1 g (typ.)

RESTRICTIONS ON PRODUCT USE

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 In developing your designs, please ensure that TOSHIBA products are used within specified operating ranges as set forth in the most recent TOSHIBA products specifications. Also, please keep in mind the precautions and conditions set forth in the "Handling Guide for Semiconductor Devices," or "TOSHIBA Semiconductor Reliability Handbook" etc..
- The TOSHIBA products listed in this document are intended for usage in general electronics applications (computer, personal equipment, office equipment, measuring equipment, industrial robotics, domestic appliances, etc.). These TOSHIBA products are neither intended nor warranted for usage in equipment that requires extraordinarily high quality and/or reliability or a malfunction or failure of which may cause loss of human life or bodily injury ("Unintended Usage"). Unintended Usage include atomic energy control instruments, airplane or spaceship instruments, transportation instruments, traffic signal instruments, combustion control instruments, medical instruments, all types of safety devices, etc.. Unintended Usage of TOSHIBA products listed in this document shall be made at the customer's own risk.
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